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	Plastic Peg PCB Lock, Tin, G	eader, 3.00mm Pitch, Dual Row, 12 Circuits, with Snap-in low Wire Capable, Black <u>Application Specification AS-43045-001 (PDF)</u> <u>Test Summary 430450004-TS-000 (PDF)</u> <u>RoHS Certificate of Compliance (PDF)</u> <u>Product Literature (PDF)</u>	Series image - Reference only
Agency Certification CSA UL General Product Family Series Application Comments Product Literature Or Product Name UPC		LR19980 E29179 PCB Headers 43045 Power, Wire-to-Board "High Temperature Square Pin Solder Type <p><p>This Molex product is manufactured from material that has the following ratings, tested by independent agencies:. a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 60695-2-13 b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12.and hence complies with the requirements set out in the International Standard IEC 60335-1 5th edition - household and similar electrical appliances - safety, section 30 Resistance to heat and fire. <p><p> The customers using this product must determine its suitability for use in their particular application through testing or other acceptable means as described in end-product glow-wire flammability test standard IEC 60695-2-11 and any applicable product end-use standard(s). <p> If it is determined during the customer's evaluation of suitability, that higher performance is required, please contact Molex for possible product options." 987650-5984 Micro-Fit 3.0TM 800754372701</p></p></p></p></p>	EU ELV Not Relevant EU RoHS Compliant REACH SVHC China RoHS Not Contained Per -ED/01/2017 (12 January 2017)
Physical Breakaway Circuits (Loaded) Circuits (maximum) Color - Resin Durability (mating cyc Flammability Glow-Wire Compliant Mated Height Material - Metal Material - Plating Mat Material - Plating Tern Material - Resin Net Weight	ing	No 12 12 Black 30 94V-0 Yes 10.29mm Brass Tin Tin High Temperature Thermoplastic 1.949/g	

Number of Rows Orientation PCB Locator PCB Retention PCB Thickness - Recommended Packaging Type Pitch - Mating Interface Plating min - Mating Polarized to PCB Shrouded Stackable Surface Mount Compatible (SMC) Temperature Range - Operating Termination Interface: Style	2 Right Angle Yes Yes 1.60mm Tray 3.00mm 0.254μ m Yes Fully No Yes -40°C to +105°C Through Hole		
Electrical Current - Maximum per Contact Voltage - Maximum	5.0A 600V		
Solder Process Data Duration at Max. Process Temperature (seconds) Lead-freeProcess Capability Max. Cycles at Max. Process Temperature Process Temperature max. C	030 SMC&WAVE 003 260		
Material Info			
Reference - Drawing Numbers Application Specification Product Specification Sales Drawing Test Summary	AS-43045-001 PS-43045, TS-43045-001-001, TS-46235-001-001 SD-43045-001 430450004-TS-000		

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